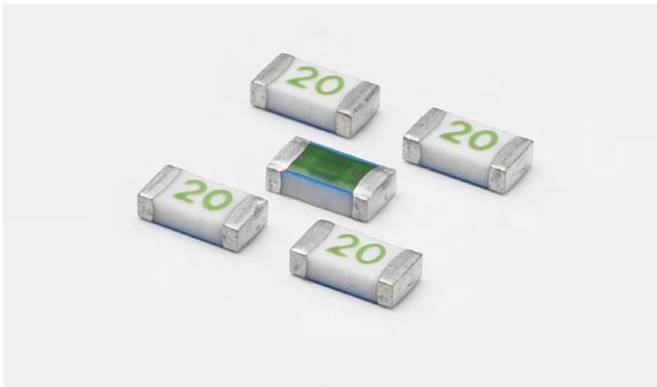


### 501 Suffix 1 Series – High Current 1206 Fast-Acting Fuse



#### Description

The 501 Series is a 100% Lead-free, RoHS compliant and Halogen-free fuse series designed specifically to provide over-current protection to circuits that operate under high working ambient temperature up to 150°C. The general design ensures excellent temperature stability and performance reliability. The high I<sup>2</sup>t values which is typical in the Littelfuse Ceramic Fuse family, ensure high inrush current withstand capability.



#### Features

- Operating Temperature from -55°C to +150°C
- Designed to provide over-current protection in high current voltage regulator module (VRM) applications
- 100% Lead-free, RoHS compliant and Halogenfree
- Suitable for both leaded and lead-free reflow /wave soldering

#### Applications

- Voltage Regulator Module (VRM) Equipment
- Notebook PC
- DC-DC Converter

#### Agency Approvals

AGENCY	AGENCY FILE NUMBER	AMPERE RANGE
	E10480	10A - 20A
	29862	10A - 20A

#### Electrical Characteristics

% of Ampere Rating(A)	Ampere Rating	Opening Time at 25°C
100%	10A - 20A	4 hours, Minimum
350%	10A - 20A	5 seconds, Maximum

#### Additional Information



Datasheet





Resources



Samples

#### Electrical Specifications by Item

Ampere Rating (A)	Amp Code	Max. Voltage Rating (V)	Interrupting Rating(DC) <sup>1</sup>	Nominal Resistance (Ohms) <sup>2</sup>	Nominal Melting I <sup>2</sup> t (A <sup>2</sup> Sec.) <sup>3</sup>	Nominal Voltage Drop At Rated Current (V) <sup>4</sup>	Nominal Power Dissipation At Rated Current (W)	Agency Approvals	
									
10	010.	32	150 A @ 32 VDC	0.00427	10.385	0.05679	0.5679	X	X
12	012.	32		0.00321	20.341	0.04891	0.5870	X	X
15	015.	32		0.00250	36.100	0.04605	0.6908	X	X
20	020.	32		0.00200	54.760	0.05936	1.1871	X	X

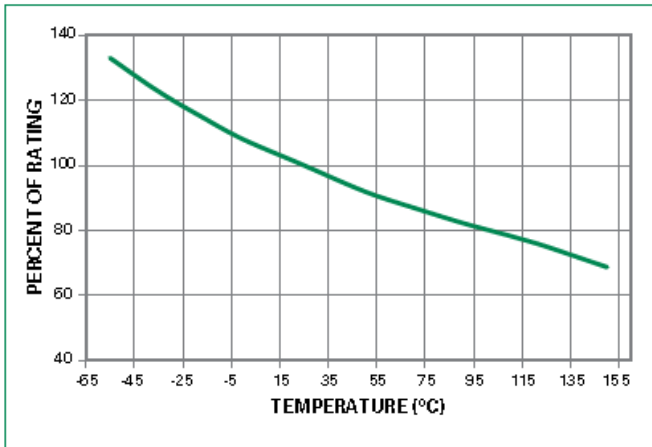
#### Notes:

- DC Interrupting Rating tested at rated voltage with time constant < 0.5 msec.
- Nominal Resistance measured with < 10% rated current.
- Nominal Melting I<sup>2</sup>t measured at 1 msec. opening time. For other I<sup>2</sup>t data refer to chart.
- Nominal Voltage Drop measured at rated current after temperature has stabilized and with fuse mounted on board with 3-oz Cu trace.

Devices designed to carry rated current for 4 hours minimum. It is recommended that devices be operated continuously at no more than 80% rated current. See "Temperature Re-rating Curve" for additional re-rating information.

Devices designed to be mounted with marking code facing up.

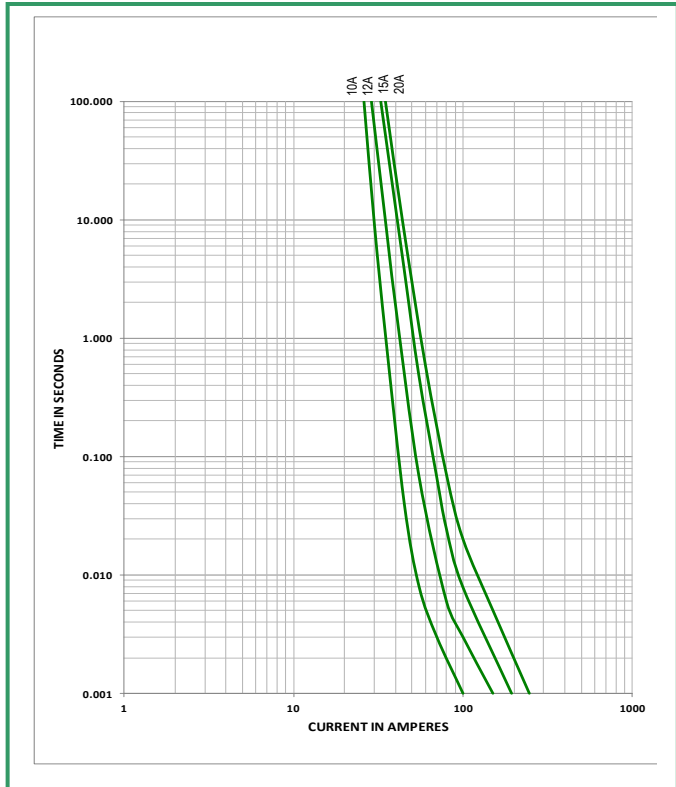
**Temperature Derating Curve**



Note:  
1. Re-rating depicted in this curve is in addition to the standard re-rating of 20% for continuous operation.

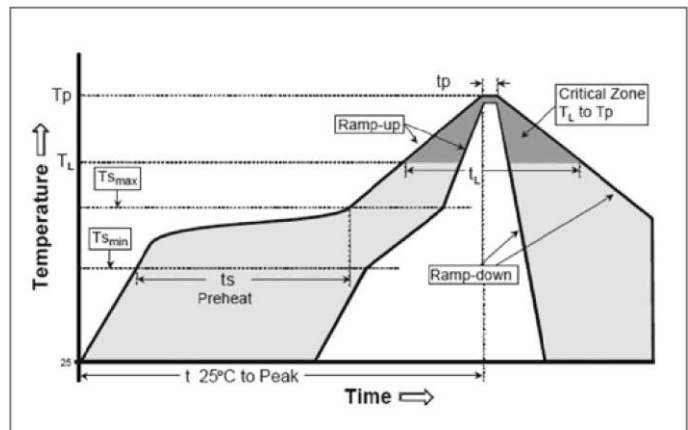
Example:  
For continuous operation at 75 degrees celsius, the fuse should be re-rated as follows:  
 $I = (0.80)(0.85)I_{RAT} = (0.68)I_{RAT}$

**Average Time Current Curves**



**Soldering Parameters – Reflow Solderingz**

Reflow Condition		Pb – Free Assembly
Pre Heat	- Temperature Min (Ts(min))	150°C
	- Temperature Max (Ts(max))	200°C
	- Time (min to max) (ts)	60 – 180 secs
Average ramp up rate (Liquidus Temp (TL) to peak)		5°C/second max
TS(max) to TL - Ramp-up Rate		5°C/second max
Reflow	- Temperature (TL) (Liquidus)	217°C
	- Temperature (tL)	60 – 150 seconds
Peak Temperature (TP)		260 <sup>+0/-5</sup> °C
Time within 5°C of actual peak Temperature (tp)		20 – 40 seconds
Ramp-down Rate		5°C/second Max
Time 25°C to peak Temperature (TP)		8 minutes Max
Do not exceed		260°C



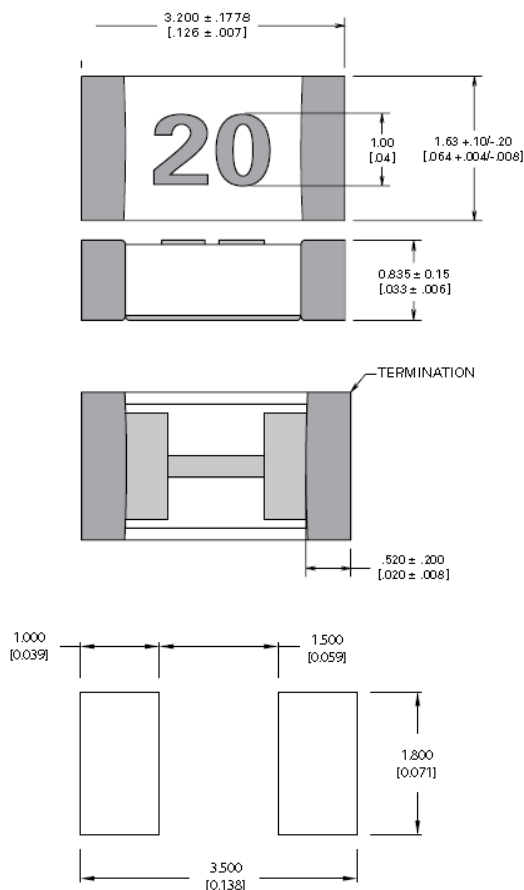
Wave Soldering	260°C, 10 seconds max.
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### Product Characteristics

<b>Material</b>	<b>Body:</b> Advanced Ceramic <b>Terminations:</b> Ag / Ni / Sn (100% Lead-free) <b>Element Cover Coating:</b> Lead-free Glass
<b>Moisture Sensitivity Level</b>	IPC/JEDEC J-STD-020, Level 1
<b>Solderability</b>	IPC/EIC/JEDEC J-STD-002, Condition B
<b>Humidity Test</b>	MIL-STD-202, Method 103, Conditions D
<b>Resistance to Solder Heat</b>	MIL-STD-202, Method 210, Condition B
<b>Moisture Resistance</b>	MIL-STD-202, Method 106

<b>Thermal Shock</b>	MIL-STD-202, Method 107, Condition B
<b>Mechanical Shock</b>	MIL-STD-202, Method 213, Condition A
<b>Vibration</b>	MIL-STD-202, Method 201
<b>Vibration, High Frequency</b>	MIL-STD-202, Method 204, Condition D
<b>Dissolution of Metallization</b>	IPC/EIC/JEDEC J-STD-002, Condition D
<b>Terminal Strength</b>	IEC 60127-4

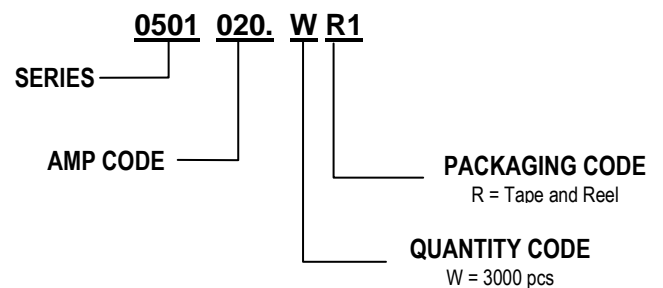
### Dimensions



### Part Marking System

Amp Code	Marking Code
010.	<b>10</b>
012.	<b>12</b>
015.	<b>15</b>
020.	<b>20</b>

### Part Numbering System



### Packaging

Packaging Option	Packaging Specification	Quantity	Quantity & Packaging Code
8mm Tape and Reel	EIA-481, IEC 60286, Part 3	3000	WR1